504433296 06/27/2017

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SUNGGIL KIM	03/26/2017
PHIL OUK NAM	03/27/2017
GUKHYON YON	03/17/2017
SUNGHAE LEE	03/16/2017
WOOJIN JANG	03/16/2017
DONGCHUL YOO	03/27/2017
HUNHYEONG LIM	03/26/2017
JUNGGEUN JEE	03/26/2017
KIHYUN HWANG	03/31/2017

RECEIVING PARTY DATA

Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	15514239	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	239/1154_00
NAME OF SUBMITTER:	EUGENE M. LEE

504433296 PATENT REEL: 042827 FRAME: 0841

SIGNATURE:	/Eugene M. Lee/	
DATE SIGNED:	06/27/2017	
Total Attachments: 6		
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PATENT REEL: 042827 FRAME: 0842

COMBINED DECLARATION (37 CFR §1.63) FOR UTILITY PATENT APPLICATION AND ASSIGNMENT FORM¹

The undersigned acknowledges that this document is being used both as an assignment of the invention and as the declaration (37 CFR 1.63) for a Utility or Design Application.

WHEREAS, the undersigned, hereinafter referred to collectively as Assignor, has invented:

Title: SEN FAI	MICONDUCTOR MEMORY DEVICES AND METHODS FOR BRICATING THE SAME
for which As for patent.	ssignor is about to make or has made United States or International application
WHEREAS,	as a below named inventor(s), I/(we) hereby declare that:
Section I. D	Declaration
This declarat	tion is directed to:
	The attached U.S. non-provisional patent application, or
	U.S. non-provisional patent application number, filed on, or
\boxtimes	PCT international patent application number PCT/IB2014/064848, filed on September 26, 2014.
The above-id	lentified application was made or authorized to be made by me (us).
I (we) believe invention in t	e that I am (we are) the original inventor (original joint inventors) of a claimed the above-identified application.
I (we) hereby punishable un both.	acknowledge that any willful false statement made in this declaration is nder 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or
	that I have reviewed and understand the contents of the above identified neluding the claims.
I acknowledg patentability	ge that I am aware of the duty to disclose information which is material to as defined in 37 CFR § 1.56.
This form req	quires the use of an Application Data Sheet.
SEC Ref No.	IE-201309-042-1-US0 Attorney Ref No. 239/1154_00

Section II. Assignment

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned hereby sell(s) and assign(s) to

Samsung Electronics Co., Ltd.

having an address at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do 16677, Republic of Korea (hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in Section I of this document.

Assignor hereby confirms any prior assignment to Assignee, and to the extent that Assignor has not already done so, agrees to assign, and hereby does, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent. utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

Assignor hereby covenants that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment; and

SEC DefNe	IE 201200 042 1 US0	Attomory Dof No	220/1154_00
SEC Ref No	IE-201309-042-1-US0	Attorney Ref No	239/1154_00
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Assignor hereby requests the United States Patent and Trademark Office to issue the Letters Patent of the United States of America to Assignee, and requests that any official of any country or countries foreign to the United States, whose duty it is to issue or grant patents and applications as aforesaid, to issue the Letters Patent, Utility Model Registration or other similar right to Assignee.

The undersigned hereby grant(s) the law firm of LEE & MORSE, PC the power to insert on this Declaration and Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

Section III. Inventor(s)/Assignor(s) Signature(s)

LEGAL NAME OF FIRST	Family Name	First Given Name	Second Given Name		
INVENTOR/ASSIGNOR	KIM	Sunggil			
SIGNATURE	SIGNATURE Kim cung gul DATE 2017/02/26				

Family Name	First Given Name	Second Given Name
NAM	Phil Ouk	
Afshork	DATE _	2012/02/21
	,	NAM Phil Ouk

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SEC Ref No.	IE-201309-042-1-US0	Attorney Ref No.	239/1154_00

LEGAL NAME OF THIRD	Family Name	First Given Name	Second Given Name
INVENTOR/ASSIGNOR	YON	Gukhyon	
	Outl.		
SIGNATURE _	anklyon you	_ DATE	2017/3/17

LEGAL NAME OF FOURTH	Family Name	First Given Name	Second Given Name
INVENTOR/ASSIGNOR	LEE	Sunghae	
SIGNATURE	Suy-How Zw	_ DATE _	20ln/3/16

LEGAL NAME OF FIFTH	Family Name	First Given Name	Second Given Name
INVENTOR/ASSIGNOR	JANG	Woojin	
SIGNATURE	JANG WOOD	DATE	2017.03/6

SEC Ref No.	IE-201309-042-1-US0	Attorney Ref No.	239/1154_00

LEGAL NAME OF SIXTH	Family Name	First Given Name	Second Given Name
INVENTOR/ASSIGNOR	YOO	Dongchul	
SIGNATURE _)///	DATE	2011. 3.21

LEGAL NAME OF SEVENTH	Family Name	First Given Name	Second Given Name
INVENTOR/ASSIGNOR	LIM	Hunhyeong	
i e			
	LIM Hunhy eon	DATE	2019.3.26

LEGAL NAME OF EIGHTH	Family Name	First Given Name	Second Given Name
INVENTOR/ASSIGNOR	JEE	Junggeun	
SIGNATURE _	Jee Jinggerin	_ DATE _	2011. 3.26

SEC Ref No.	IE-201309-042-1-US0	Attorney Ref No.	239/1154_00

LEGAL NAME OF NINTH	Family Name	First Given Name	Second Given Name
INVENTOR/ASSIGNOR	HWANG	Kihyun	
SIGNATURE _	3/7/m	DATE_	3/31/2017



SEC Ref No. IE-201309-042-1-US0 Attorney Ref No. 239/1154_00